

# euspen | challenge

euspen Challenge is an **international** competition to identify exceptional students across Europe with the potential to be future leaders in the field of precision engineering and nanotechnology.

Following National Competitions, each participating country will select 3 students to join the euspen Challenge final where they will be grouped into international teams and provided with a technical task to complete within a limited time. Presentations of the task solution will be made to a jury of international academics and industrialists.

One team will be awarded the coveted title of **“Overall International Winning Team.”**

*“It was a memorable experience for me personally, having met lots of people from all across Europe. It was nice making contacts and friends”*

*“I have enjoyed the experience a lot and the most important thing, I have met really interesting people with whom now I will keep the contact and the relationship that started thanks to you and your organisation”*



[www.studentchallenge.euspen.eu](http://www.studentchallenge.euspen.eu)

# euspen membership

Join **euspen's** worldwide network to enhance your skills; expand your professional knowledge; and access a vibrant local and global community of colleagues who set the standard for innovation in the field of precision, micro and nano engineering

Discover how the **euspen** community comes together on a world-class platform. Access the greatest minds to stimulate ideas and solutions; share knowledge, exchange information and develop friendships.

Become a part of the **euspen** experience today, driving the next generation in shaping the future.

Benefits include:

- Access through **euspen's** members only website to over 2000 peer-reviewed technical papers published by euspen
- Immediate access of technical matter (papers and presentations) from **euspen** special interest group meetings, international conferences and Lamdamap
- Copy of professional journals (Precision Engineering; Mikroniek)
- Reduced fees for euspen conferences and exhibition booths, seminars, training courses and euspen publications.
- Facility to post vacancies on **euspen** website\*
- Access to details to MSc/PhD students studying in the field for recruitment purposes and **euspen** Challenge participants\*
- The opportunity to serve on the Society's Council and Committees

*\*Only available if sponsor/corporate membership is taken.*

*For a complete list of benefits please visit [www.euspen.eu](http://www.euspen.eu)*



## Upcoming Events and Activities:

- SIG – Micro/Nano Manufacturing, 27-28 November 2013, KIT campus, Karlsruhe, Germany
- SIG – Thermal Effects, 19-20 March 2014, Novotel Hotel, Zurich, Switzerland
- euspen's 14th International Conference & Exhibition, 2-6 June 2014, Valamar Lacroma Hotel, Dubrovnik, Croatia
- euspen Challenge 2014, July 2014, Germany
- SIG – Surface & Freeform Surfaces, November 2014, Padova, Italy

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